# 504687364 12/14/2017

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT

EPAS ID: PAT4734086

# **CONVEYING PARTY DATA**

**NATURE OF CONVEYANCE:** 

Name	Execution Date
HIROMICHI TAKAOKA	11/01/2017

**ASSIGNMENT** 

### **RECEIVING PARTY DATA**

Name:	RENESAS ELECTRONICS CORPORATION
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City:	TOKYO
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#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15839634

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ATTORNEY DOCKET NUMBER: REN.390

NAME OF SUBMITTER: SEAN M. MCGINN

SIGNATURE: /Sean M. McGinn/

DATE SIGNED: 12/13/2017

**Total Attachments: 2** 

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PATENT 504687364 REEL: 044394 FRAME: 0852

Docket No. REN . 340 Only After Sept 18, 2012

#### ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (\$7 CFR 1.63)

Whereas, I/We, the undersigned inventor(s) hereinafter called assignor(s), have invented certain improvements described in the application identified below; and

Whereas, Renesas Electronics Corporation of 2-24, Toyosu 3-chome, Koutou-ku, Tokyo 135-0061, Japan, (assignes), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the shove named assignor(s), hereby sell, assign and transfer to the above named assignes, its successors and essigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 USC 118, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

consideration all papers deemed neces the assignee.	sary by	the assignee in connection with the United States application when called upon to do so by
(Legalization not required for recording	but is	prims facia evidence of execution under 35 USC 261)
As the below named inventor, I hereby	declare	that
This assignment with declaration is directed to:	X	The attached application, or
		United States Application or PCT International Application Number
		filed on
The application is entitled:		
		SEMICONDUCTOR DEVICE
The above identified application was m	ada or 1	was authorized to be made by me.
I believe that I am the original inventor	or an o	original joint inventor of a claimed invention in the application.
I have reviewed and understand the co	ntents	of the application for which this assignment with declaration is being submitted
I am aware of the duty to disclose to ti	ne Offic	e all information known to me to be material to patentability as defined in 37 CFR 1.56.
I hereby acknowledge that any willful fa or imprisonment of not more than five	ilse stø (5) year	tement made in this assignment with declaration is punishable under 18 USC 1001 by fine is, or both.
Authorization To Permit Access To A	pplicati	on by Participating Office
(JPO), the Korean Intellectual Property property offices in which a foreign appl patent application, Ses 37 CFR 1.14(c)	Office leation and (h)	the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual claiming priority to the above—identified application is filed access to the above—identified this box should not be checked if the applicant does not wish the EPO, UPO, CIPO, or reign application claiming priority to the above—identified application is filed to have
identified patent application—as-filed, 2 119(a)-(d) if a copy of the foreign appli	) any fo cation t	will be provided to a copy of the application—as—filed with respect to: 1) the above— reign application to which the above—identified application claims priority under 35 USC that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above— oplication—as—filed from which benefit is sought in the above—identified patent application.
In accordance with 37 CFR 1.14(c), acc	ess ma Offica	by be provided to information concerning the date of filing the Authorization to Permit

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Inventor's Signature

| Description: | Description:

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